



Material Content Data Sheet



Sales Product Name		IGW60T120		Issued		23. January 2018			
MA#		MA000919758							
Package		PG-TO247-3-41		Weight*		6053.53 mg			
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]	
chip	inorganic material	silicon	7440-21-3	15.927	0.26	0.26	2631	2631	
leadframe	non noble metal	iron	7439-89-6	3.972	0.07		656		
	inorganic material	phosphorus	7723-14-0	1.192	0.02		197		
	non noble metal	copper	7440-50-8	3967.074	65.54	65.63	655334	656187	
wire	non noble metal	aluminium	7429-90-5	13.501	0.22	0.22	2230	2230	
encapsulation	organic material	carbon black	1333-86-4	19.829	0.33		3276		
	plastics	epoxy resin	-	376.753	6.22		62237		
	inorganic material	silicondioxide	60676-86-0	1586.326	26.20	32.75	262050	327563	
leadfinish	non noble metal	tin	7440-31-5	31.874	0.53	0.53	5265	5265	
plating	non noble metal	nickel	7440-02-0	29.065	0.48	0.48	4801	4801	
solder	non noble metal	antimony	7440-36-0	0.801	0.01		132		
	noble metal	silver	7440-22-4	2.003	0.03		331		
	non noble metal	tin	7440-31-5	5.208	0.09	0.13	860	1323	
*deviation	< 10%					Sum in total:	100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

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